Sub-picosecond 1030 nm laser-induced damage threshold evaluation of pulsed-laser deposited sesquioxide thin films

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Abstract. Dielectric sesquioxide films (Sc₂O₃, Y₂O₃, and Lu₂O₃) were fabricated by pulsed-laser deposition and tested in terms of their laser damage properties for pulses of 500 fs duration, at a wavelength of 1030 nm and at a 10 Hz repetition rate. Comparable tests were performed with magnetron-sputtered thin films of established optical-coating materials (SiO₂, HfO₂, and Nb₂O₅), whose results served as a benchmark. The laser-induced damage thresholds of the sesquioxides are comparable to each other, and in the multi-pulse test regime show values close to ones of HfO₂ coatings. A lower damage threshold was observed for the polycrystalline Lu₂O₃ film grown on sapphire compared to single-crystal Lu₂O₃ grown on yttrium aluminium garnet (Y₃Al₅O₁₂), attributed to the highly textured morphology and potential for a greater density of defect states in these films. We conclude that pulsed-laser deposition is a potential fabrication method of sesquioxides for use in high-power resistant optical components for ultrashort-pulse lasers. © The Authors. Published by SPIE under a Creative Commons Attribution 4.0 International License. Distribution or reproduction of this work in whole or in part requires full attribution of the original publication, including its DOI. [DOI: 10.1117/1.OE.61.7.071603]

Keywords: laser damage; pulsed-laser deposition; thin films.

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1 Introduction

The laser-induced damage threshold (LIDT) of optical components represents the limiting factor of the useful performance of ultrafast solid-state lasers. To improve the LIDT of optical materials, especially optical coatings, considerable efforts have been made to test diverse materials, develop new optimized coating designs, and advanced fabrication methods. Among the plethora of thin-film growth techniques, pulsed-laser deposition (PLD) is considered to be one of the most versatile and powerful. In comparison to other deposition techniques such as sputtering or chemical vapor deposition, PLD enables crystalline thin-film growth at relatively low substrate temperatures. PLD also provides the ability to deposit several multicomponent materials in situ with preserved stoichiometry. Since the pioneering PLD work from Smith and Turner in 1965, the technique has been used for deposition of a wide range of materials and recently proved to be a reliable method for optical-coating fabrication.

In the past decade, mirrors based on the combination of HfO₂, a high-refractive-index material, and SiO₂, a low-refractive-index material, received considerable attention. However, the published sub-picosecond (ps) LIDT results for Sc₂O₃ or Y₂O₃ films, indicate that sesquioxides might be good alternatives for HfO₂. Especially Sc₂O₃, which is a promising high-refractive-index material that exhibits slightly larger optical bandgap (5.7 eV) than HfO₂ (5.55 eV). In fact, electron-beam-deposited Sc₂O₃ and Y₂O₃ thin films, tested at 500 fs and 1030 nm by a single shot and 100 shots at 10 Hz repetition rate, showed LIDTs comparable to that of HfO₂. The laser damage resistance at 500 fs and 1030 nm was also measured for
ion-beam sputtered Sc₂O₃ for which its 1-on-1 internal damage threshold reached a value of 3.1 J/cm².²⁵ It has to be pointed out that most of the laser damage studies of Sc₂O₃ have been motivated by the development of optical interference coatings in the UV range.²⁸,³¹–³³ To the best of our knowledge, all the LIDT studies conducted on sesquioxide films focused either on amorphous or polycrystalline films. Consequently, the results might differ from films produced via PLD, which has the potential to grow single-crystal films.²¹,³⁴,³⁵

In this work, we prepared pulsed-laser deposited Sc₂O₃, Lu₂O₃, and Y₂O₃ sesquioxides and tested them in terms of sub-ps-pulse laser damage. Comparable tests were also performed with magnetron-sputtered (MS) thin films of established optical-coating materials (SiO₂, HfO₂, and Nb₂O₅), whose results served as a benchmark. The LIDT values for these more standard materials have been reported in studies comparing them with numerous optical-coating materials.³⁰

The thin films studied in this report are intended to be used in dielectric multilayer mirrors or diffractive gratings, particularly grating waveguide structures (GWSs).³⁶ The latter elements offer the possibility to control the temporal,³⁷ spectral,³⁸ or spatial profile of light within or from high-power laser systems.³⁹ This study intends to explore the sesquioxides as potentially interesting materials for use in high-power ultrashort-pulse laser systems. Moreover, the uniqueness of this study lies in the testing of non-traditional sesquioxide materials in their crystalline form. In the case of Lu₂O₃ thin films, we are not aware of any laser damage-related publication in the sub-ps regime.

The following sections describe the deposition techniques used: pulsed-laser deposition and magnetron sputtering. Then the tested samples and their parameters are introduced. This is followed by an explanation of the characterization methods used to qualify the thin-film materials. Afterward, the LIDT station and the procedure employed are described. Finally, the laser damage results are given and their dependence on the number of shots, material bandgap, refractive index, and deposition method is discussed.

2 Sample Fabrication

2.1 Pulsed-Laser Deposition

The deposition of the films investigated in this study was performed with the PLD setup depicted schematically in Fig. 1 and described in more details in Refs. 21, 35, and 40. The targets were fabricated by sintering powders of the materials of interest, which ensures a stoichiometric proportion of the elements, and had a final mass of ~85% of the expected mass for the pure crystalline material of the same volume. Target ablation was achieved using a KrF excimer laser operating at 248 nm, with a pulse duration of ~30 ns and a repetition rate of 100 Hz, yielding growth rates ranging from 10 (Lu₂O₃) to 20 μm/h (Sc₂O₃). The motion of the target was configured to obtain an effective bi-directional ablation, which was proven to significantly reduce the number of scattering points in the as-grown films.⁴⁰ A Metricon (Model 2010) prism coupler equipped with a #200-P-2 prism, and a HeNe laser source operating at 633 nm was used to determine the refractive index and thickness of the films investigated.

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**Fig. 1** Pulsed-laser deposition setup.
To achieve crystalline-film growth, during deposition the rear surface of the substrate was heated by a CO₂ laser operating at 10.6 μm. The original Gaussian intensity distribution of the beam was transformed by a ZnSe tetraprism into a nearly-uniform profile, which fits the substrate’s dimensions. The substrate temperature used for the deposition of the samples ranged from 950°C to 1100°C, depending on the material.

The background pressure of the vacuum chamber could be tuned by manually adjusting an oxygen gas in-flow. All sesquioxide films analyzed in this report were deposited at a background pressure of 20(±0.01) μbar.

The deposition parameters of the investigated samples are listed in Table 1. Optimization of the parameters had been conducted previously and the samples for LIDT measurements were selected based on their crystalline properties and surface homogeneity (in terms of the number of scattering points visible under a dark field microscope).

### 2.2 Magnetron Sputtering

MS samples were produced with a Helios coater developed by Bühler Leybold optics. The layers were deposited by the plasma-assisted reactive magnetron sputtering (PARMS) process. Inside the Helios coater, samples are placed on a rotating plate. At first, the sample passes under a mid-frequency dual magnetron, where a thin substoichiometric layer is deposited from a metallic target. Then the sample passes under a radio frequency plasma source where the thin layer is oxidized. The PARMS process, therefore, produces high-density oxide coatings. The speed of rotation and power of magnetron is adjusted to deposit ~0.1 nm of thin-film in each rotation. Each individual thin-film-layer thickness is controlled by in situ optical monitoring. Optical measurement is performed at each passing of the substrate under the measurement window. This allows the single-layer thickness to be controlled to better than 1 nm accuracy. Both monochromatic and broadband monitoring can be used in this setup.

Typical pressure inside the vacuum chamber during deposition is 50 nbar. An argon and oxygen mix is used as a process gas for magnetron sputtering, while oxygen is used as the source gas in the plasma for thin-film oxidation. Both high- and low-index materials can be coated within one production cycle.

Previous studies have been conducted on films produced by this machine and their LIDT values compared to a large set of samples produced by different methods and manufacturers, exhibiting LIDT in accordance with the state-of-the-art.

### 3 Characterization of the Thin Films

#### 3.1 Samples to Be Tested

The tested samples were monolayers of Y₂O₃, Sc₂O₃, Lu₂O₃, HfO₂, Nb₂O₅, and SiO₂ (See Table 2). The crystalline sesquioxide materials (Y₂O₃, Sc₂O₃, and Lu₂O₃) were deposited

<table>
<thead>
<tr>
<th>Substrate material and orientation</th>
<th>Film</th>
<th>Target ablation fluence (J/cm²)</th>
<th>Heating power (W)</th>
<th>(222) XRD peak position (deg)</th>
<th>Film lattice constant (Å)</th>
</tr>
</thead>
<tbody>
<tr>
<td>YAG &lt;100 &gt;</td>
<td>Lu₂O₃</td>
<td>1.21</td>
<td>26.7</td>
<td>29.79</td>
<td>10.390</td>
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<tr>
<td>Sapphire &lt;0001 &gt;</td>
<td>Lu₂O₃</td>
<td>1.27</td>
<td>26.2</td>
<td>29.76</td>
<td>10.399</td>
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<tr>
<td>Sapphire &lt;0001 &gt;</td>
<td>Y₂O₃</td>
<td>1.19</td>
<td>18.0</td>
<td>29.10</td>
<td>10.910</td>
</tr>
<tr>
<td>Sapphire &lt;0001 &gt;</td>
<td>Sc₂O₃</td>
<td>1.24</td>
<td>24.0</td>
<td>31.50</td>
<td>9.840</td>
</tr>
</tbody>
</table>

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on a <0001>-oriented sapphire substrate. In the case of Lu2O3 material, one sample was deposited on a <100>-oriented yttrium aluminum garnet (YAG) substrate. The amorphous metal oxides (HfO2, Nb2O5, and SiO2) were deposited on fused silica (FS) using the magnetron sputtering process.

### 3.1.1 Refractive index measurement

The refractive indices of the MS samples were determined by spectrophotometry using numerical fitting methods to the transmittance and reflectance measurements in the low-absorptance spectral region. The values of refractive indices at 1030 nm are listed in Table 2. In the case of pulsed-laser deposited materials, the dispersion curves were determined using ellipsometry. The refractive indices of Y2O3 (1.90 @1030 nm) and Sc2O3 (1.97 @1030 nm) correspond well with published values.46,47 Extinction coefficients were measured by ellipsometry, however, given the uncertainty of the method, we can only assess that the extinction coefficient values are below $10^{-2}$ at 1030 nm.

### 3.1.2 Bandgap measurement

The optical bandgap values of the tested samples were derived from each film’s intrinsic absorption coefficient, $\alpha$, by plotting $(\alpha E)^{1/2}$ as a function of the photon energy $E$ and extrapolating the linear curve to the abscissa axis. The bandgap error margins were estimated using the photon energies corresponding to absorption coefficients of $10^3$ and $10^4$ cm$^{-1}$.48,49 The value of SiO2 bandgap was taken from Ref. 44 because the absorption edge could not be reached with our instruments.

### 3.2 X-Ray Diffraction

Epitaxial growth of the Y2O3, Lu2O3, and Sc2O3 films on the <0001>-cut sapphire was expected to be predominantly in the <111>-direction, since the lattice mismatch in this orientation is the smallest with substrate orientation, i.e., 4.9%, 2.9%, and 2.5%, respectively. Similarly, Lu2O3 <111> has a quasi-perfect lattice match with <100>-cut YAG, that facilitates the growth of that orientation.

The out-of-plane x-ray diffraction (XRD) patterns from the samples were recorded by a Rigaku Smartlab, equipped with a Ge(220) 2-bounce monochromator. Two different sets of parameters were selected for the scans. A wide scan with a 2θ value from 20 deg to 80 deg and a step size of 0.02 deg was used to compare the proportion of the different orientations

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**Table 2**  Tested thin-film materials and their parameters, $n$ means refractive index at 1030 nm wavelength. The Sc2O3, Y2O3, and Lu2O3 sesquioxides were PLD-grown in the Optoelectronics Research Centre (Southampton, United Kingdom). The HfO2, Nb2O5, and SiO2 were MS in the Institut Fresnel (Marseille, France).

<table>
<thead>
<tr>
<th>Material</th>
<th>Thickness (nm)</th>
<th>$n$</th>
<th>Bandgap (eV)</th>
<th>Deposition</th>
<th>Substrate</th>
</tr>
</thead>
<tbody>
<tr>
<td>Sc2O3</td>
<td>1750</td>
<td>1.97</td>
<td>5.74</td>
<td>PLD</td>
<td>Sapphire</td>
</tr>
<tr>
<td>Y2O3</td>
<td>1310</td>
<td>1.90</td>
<td>5.44</td>
<td>PLD</td>
<td>Sapphire</td>
</tr>
<tr>
<td>Lu2O3</td>
<td>970</td>
<td>1.91</td>
<td>5.43</td>
<td>PLD</td>
<td>Sapphire</td>
</tr>
<tr>
<td>Lu2O3</td>
<td>1000</td>
<td>1.91</td>
<td>5.43</td>
<td>PLD</td>
<td>YAG</td>
</tr>
<tr>
<td>HfO2</td>
<td>250</td>
<td>2.03</td>
<td>5.25</td>
<td>MS</td>
<td>FS</td>
</tr>
<tr>
<td>Nb2O5</td>
<td>450</td>
<td>2.26</td>
<td>3.41</td>
<td>MS</td>
<td>FS</td>
</tr>
<tr>
<td>SiO2</td>
<td>450</td>
<td>1.47</td>
<td>8$^b$</td>
<td>MS</td>
<td>FS</td>
</tr>
</tbody>
</table>

$^a$HfO2 is not pure but contains ~1% to 2% of SiO2 admixture.45
$^b$The SiO2 bandgap was taken from Ref. 44.
in the film. Since the films were expected to grow preferentially in the <111>-direction, the (222) diffraction peak was our main peak of interest. Secondly, an additional high-resolution scan with a step size 0.002 deg was made around this primary peak.

Figure 2 displays the XRD patterns of the films with each peak labeled with the corresponding orientation. The Y$_2$O$_3$ and Sc$_2$O$_3$ films grew primarily in the <111>-orientation, as demonstrated by the dominance of the (222) peak. The height ratio between the (222)-peak and the peaks corresponding to other orientations is greater than 3000. However, the Lu$_2$O$_3$ film grown on sapphire exhibits strong polycrystalline characteristics, with several orientations that have a height ratio of <30 with the (222) peak. On the contrary, the growth of <111>-oriented Lu$_2$O$_3$ is clearly favored on the YAG substrate: the XRD figure shows also that the (222) peak is 1500 times stronger than the next visible orientation (332) and is nearly perfectly superimposed with the YAG (400) peak at a 2θ angle of 29.8 deg. This aspect is highlighted in the high-resolution XRD pattern of that sample in Fig. 3b, with a clear double-peak lying at 29.8 deg.

![XRD patterns](https://example.com/xrd Patterns)

**Fig. 2** Wide XRD scans of the PLD samples: (a) Lu$_2$O$_3$ film on YAG substrate, (b) Lu$_2$O$_3$ film on sapphire substrate, (c) Y$_2$O$_3$ film on sapphire substrate, and (d) Sc$_2$O$_3$ film on sapphire substrate.

**Fig. 3** (222) XRD peaks of the Y$_2$O$_3$, Lu$_2$O$_3$, and Sc$_2$O$_3$ films grown on <0001>-sapphire. (b) (222) XRD peak of the Lu$_2$O$_3$ films grown on <0001>-sapphire and <100>-YAG.
Figure 3 compares the position of the (222) peak of the different films, which was used to calculate their lattice constants. The results, summarized in Table 1, show that the lattice constant of the as-grown films is close to the value reported for the corresponding bulk materials.50,51

4 Description of LIDT Station and Test Procedure

4.1 Test Station
The test station used for LIDT tests is described in Ref. 52 detailing the description of test procedures and metrology methods. For the results reported here in this study, the pulses of nearly Gaussian spatial profile and ~500 fs pulse duration at ~1030 nm wavelength were incident at a repetition rate of 10 Hz. The maximum achievable pulse energy on a sample was 0.85 mJ. Characterization of the spatial and temporal profiles as well as an energy calibration were carried out before and after the LIDT test campaign. The LIDT tests were performed with samples placed at the focal plane of the lens with 30 cm focal length. The effective beam diameter, as defined by international standards,53 was 84 μm in a plane perpendicular to the beam propagation. The LIDT tests were performed in an air environment at a room temperature of 25°C and humidity around 27%. A typical spatial beam profile at the focal plane, autocorrelation trace, and spectral distribution are shown in Fig. 4.

4.2 LIDT Procedure and Damage Detection
Each sample was irradiated at different spots with unique pulse energies that were changed with a ~1% energy increment in order to get statistical data. The procedure was repeated for different numbers of pulses—from single-shot up to 1000 shots at 10 Hz. The LIDT tests were done at a 45-deg incidence angle with P-polarization. The irradiated sites were analyzed ex situ using a Zeiss Axiotech differential interference contrast microscope with 20× objective magnification. Any observable material modification was evaluated as damage. The damage threshold was determined as the highest fluence that is lower than the lowest fluence causing damage in the experiment. The error bars correspond to the sum of 3σ variations of effective beam area near focal plane (~3%), pulse energy (~0.7%), and a half of pulse energy increment (~0.5%).

4.3 Intrinsic LIDT Fluence
Since the optical layers are the scene of interference effects, the distribution of the electric field inside the layer irradiated by the laser is not homogeneous. The electric field distribution is critical for understanding sub-ps LIDT results since the excitation of dielectrics is governed by electronic processes. To compare LIDT results, accounting for the conditions influencing the electric field distribution, e.g., angle of incidence, polarization, layer thickness, or refractive index, it is necessary to rescale the LIDT results with the electric field intensity (EFI) maximum (\(E_{\text{FImax}}\)) within the given layer. Therefore, the fluence values reported in this study correspond to \(F_{\text{int}}\) intrinsic fluence determined using \(F_{\text{exp}}\) external fluence and the \(E_{\text{FImax}}\) and the relation is given by
where the $E_{\text{max}}$ represents the maximum value of the electric field in the layer and the $E_{\text{inc}}$ means incident electric field amplitude. The correction factor of incidence angle during the damage tests (45 deg) is taken into account within the $EF_{\text{Imax}}$ calculation. The distribution of the relative EFI for the $\text{Sc}_2\text{O}_3$ layer used in our experiment is shown in Fig. 5.

5 Laser Damage Results and Discussion

5.1 Deterministic 0 to 1 Transition

To evaluate the uniformity of the tested materials in terms of laser damage, the transition range of the damage probability, as indicated in Fig. 6(a), was calculated for each material and number of pulse combinations. The transition range is defined by the relative fluence at which the damage probability changes from 0 to 1. The transition range is expressed in relative fluence, as indicated in Fig. 6(b). Intrinsic LIDT fluence as a function of shot number is shown in Fig. 6(c). The intrinsic LIDT fluence was calculated using the formula:

$$F_{\text{int}} = EF_{\text{Imax}} \cdot F_{\text{exp}} = \frac{E_{\text{max}}}{E_{\text{inc}}}^2 \cdot F_{\text{exp}},$$

where $E_{\text{max}}$ represents the maximum value of the electric field in the layer and $E_{\text{inc}}$ means incident electric field amplitude. The correction factor of incidence angle during the damage tests (45 deg) is taken into account within the $EF_{\text{Imax}}$ calculation. The distribution of the relative EFI for the $\text{Sc}_2\text{O}_3$ layer used in our experiment is shown in Fig. 5.

Fig. 6 Laser damage results for materials used in GWS: (a) example of the damage probability results in the case of 100-on-1 tests with $\text{Lu}_2\text{O}_3$ deposited on sapphire; (b) transition ranges for the damage probability expressed in relative fluence, as indicated in Fig. 6(a); and (c) intrinsic LIDT fluence as a function of shot number. The $\text{Sc}_2\text{O}_3$, $\text{Lu}_2\text{O}_3$, and $\text{Y}_2\text{O}_3$ films were fabricated by pulsed-laser deposition, while $\text{HfO}_2$, $\text{Nb}_2\text{O}_5$, and $\text{SiO}_2$ by magnetron sputtering. All samples were tested with pulse duration of 500 fs at 1030 nm.
shots used, see Fig. 6(b). The 1-on-1 laser damage tests with Sc$_2$O$_3$, Y$_2$O$_3$, SiO$_2$, HfO$_2$, and Nb$_2$O$_5$ show deterministic results, i.e., narrow transition ranges of damage probability from 0 to 1. The transition range of damage probability was only a few percent in fluence, which suggests that the LIDT is limited by intrinsic material properties rather than by defects or impurities caused by the deposition process. However, in the case of Lu$_2$O$_3$, we found wider transition ranges that could be a consequence of film imperfections, especially in the case of the film grown on sapphire that could be connected to the polycrystalline nature of this film, see Fig. 7. The larger ranges for the multiple-pulse tests may be due to the stochastic formation of deep and shallow traps in the bandgap, which facilitates electron excitation and material modification.

5.2 LIDT—Single Shot

The intrinsic LIDT fluence as a function of shot number for different thin-film materials is shown in Fig. 6(c). Among the tested materials, the SiO$_2$ film shows the highest LIDT while Nb$_2$O$_5$ shows the lowest. In between, we find the other high-index materials, namely HfO$_2$, Sc$_2$O$_3$, Y$_2$O$_3$, and Lu$_2$O$_3$, that are interesting for high-power applications. HfO$_2$, a widely used high-index material in optical mirrors, showed a single-shot LIDT of 2.3 J/cm$^2$, which is higher than the values around 2.0 J/cm$^2$ published in the previous works performed under the conditions close to ones used in this study (1030 nm, 500 fs). The higher LIDT of the tested HfO$_2$ can be explained by the inclusion of SiO$_2$ in the deposited film, which was estimated from the dispersion curve to be around 1% to 2%. The effect of the SiO$_2$ admixture on the HfO$_2$ damage threshold is in agreement with previous work.

5.3 LIDT—Multiple Shots

For all materials, the LIDT is decreasing with an increasing number of shots, see Fig. 6(c). The results show a drop of >20% of the threshold within the first 100 shots. In contrast, at the transition from 100 to 1000 pulses, we observe only a small decrease. These tendencies were already observed in works performed at similar irradiation conditions with metal oxide coatings. The gradual decrease is associated with the formation of laser-induced defects, leading to accessible energy levels within the bandgap. The deep or shallow traps can capture electrons from the conduction band even after a sub-threshold irradiation.

In the case of Sc$_2$O$_3$, the drop in LIDT is more noticeable than for the other sesquioxides and reaches that of HfO$_2$. The larger 1-on-1 LIDT of Sc$_2$O$_3$ compared to HfO$_2$ was also observed in work with ion-beam sputtered (IBS) films which could be related to imperfect damage detection. Going to a higher number of pulses, the HfO$_2$ deposited on FS, Y$_2$O$_3$ on Al$_2$O$_3$, Sc$_2$O$_3$ on Al$_2$O$_3$, and Lu$_2$O$_3$ on YAG, samples show very similar LIDT, indicating that any of these materials could be recommended for high-power applications, as far as LIDT is concerned.
The 1-on-1 and 100-on-1 LIDT values of \( \text{Y}_2\text{O}_3 \), \( \text{Sc}_2\text{O}_3 \), and \( \text{HfO}_2 \) materials were determined to be close to each other in the study,\(^{11} \) devoted to electron-beam deposited (EBD) single-layers on FS substrates. The LIDT tests were performed at identical conditions to this work (500 fs, 1030 nm, and 10 Hz).

In the case of \( \text{Lu}_2\text{O}_3 \) deposition on an \( \text{Al}_2\text{O}_3 \) substrate, we observe significantly lower LIDT values, which could be explained by the polycrystalline and highly textured nature of the film (Fig. 7). The presence of multiple crystal orientations implies the existence of discontinuities in the lattice that may potentially modify the local bandgap of the material. These boundaries between domains of different orientations may initiate the damage.

### 5.4 Bandgap

Since the laser-damage initiation in the sub-ps regime is driven by nonlinear ionization, the bandgap represents a critical parameter that correlates with the laser-damage resistance.\(^{55} \) The behavior can be explained by taking into account the electron excitation processes playing a dominant role at the beginning of damage formation, i.e., multiphoton and impact ionization.\(^{2} \) The intrinsic threshold fluences of tested materials are plotted as a function of their bandgap values in Fig. 8(a). We observe a linear tendency of increasing single-shot LIDT with a larger bandgap value that is in agreement with the studies performed at similar irradiation conditions in Refs. 30 and 60.

The deviations from the linear tendency in Fig. 8(a) can be explained by the challenges faced to observe the material modifications induced by single-shot irradiation, see Fig. 7. Moreover, some of the sesquioxide crystal films exhibit imperfections that include defect sites. For example, the lower LIDT of \( \text{Lu}_2\text{O}_3 \) on sapphire could have been caused by its polycrystalline structure, enabling lower local bandgap values at domain boundaries for different lattice orientations. It should be highlighted that the Tauc method provides a measure of the bandgap at a macroscopic scale, while on the microscopy level there are likely to be numerous defects in the polycrystalline film. Even in the case of the near single-crystal \( \text{Lu}_2\text{O}_3 \) on YAG, the error bars on the bandgap would be larger than that determined from the Tauc measurement method used.

In this work, the LIDT (in J/cm\(^2\)) tendency on bandgap \( E_g \) (in eV) can be well fitted by the following equation

\[
\text{LIDT} = 0.8 \times E_g - 1.93.
\]

(b) The bandgap was determined using the Tauc method.

![Fig. 8](https://www.spiedigitallibrary.org/journals/Optical-Engineering)
within the high-index materials. The determined bandgap value for the Sc$_2$O$_3$ film tested (5.7 eV) is close to the bandgap of ion-beam sputtered Sc$_2$O$_3$ (5.6 eV). However, larger bandgaps have been reported for electron-beam deposition (EBD) of Sc$_2$O$_3$ (6.5 eV) or Y$_2$O$_3$ (6.1 eV) compared with the samples tested here grown by PLD, i.e., Sc$_2$O$_3$ (5.7 eV) or Y$_2$O$_3$ (5.4 eV). It should be noted that care should be taken when comparing bandgaps across publications since the bandgap is not exactly defined and can be determined using different methods.

5.5 Refractive Index

For the design of multilayer components and GWS in our case, the critical parameter is the refractive index. Thus, in Fig. 8(b), we plot the intrinsic 1-on-1 LIDT of the tested materials as a function of refractive index. The results confirm the trend of increasing refractive index with decreasing intrinsic 1-on-1 LIDT, which was also observed in works performed at similar irradiation conditions (500 fs, 1030 nm). Amorphous and single-crystal materials appear to follow the trend, while polycrystalline sesquioxides, such as Lu$_2$O$_3$ and Al$_2$O$_3$, seem to be susceptible to a lower LIDT. This could be due to local defects associated with domain boundary interfaces and the highly textured surface. Based on the comparison, Sc$_2$O$_3$ seems to be the most promising of the sesquioxides, showing both high damage resistance and a high refractive index value. Furthermore, the pulsed-laser deposited Sc$_2$O$_3$ (1.97) shows a higher refractive index @1030 nm than the ion-beam sputtered one (1.93) or the EBD Sc$_2$O$_3$ (1.82). The refractive index of the PLD Y$_2$O$_3$ samples studied here is the same as that of EBD Y$_2$O$_3$ (1.90).

5.6 Deposition Methods

Thanks to the LIDT studies performed under identical conditions using the same experimental setup like this work (500 fs, 1030 nm), we can compare the LIDT values of sesquioxides deposited by different fabrication methods as shown in Fig. 9. For both Sc$_2$O$_3$ and Y$_2$O$_3$, the laser damage resistance of the PLD samples is comparable to that of EBD layers. The thresholds of both PLD and EBD samples indicate a similar fatigue effect—decrease between the 1-on-1 and 100-on-1 thresholds. In the case of 1-on-1 Sc$_2$O$_3$ thresholds, the differences between PLD, EBD, and IBS deposition methods can be explained by the difficulty of the detection of material changes. Furthermore, the higher 1-on-1 LIDT of Sc$_2$O$_3$ layer fabricated by IBS compared with that of the PLD grown layer could be explained by a 1.6% Si fraction of Sc+Si content in the IBS layer.

5.7 Sesquioxides in Multilayer Coatings

Lattice-matching constraints strongly limit the potential combinations of materials involving crystalline sesquioxides. Among the materials studied, Sc$_2$O$_3$ and α−Al$_2$O$_3$ have the largest

![Fig. 9](image_url) Intrinsic LIDT fluence for (a) Sc$_2$O$_3$ and (b) Y$_2$O$_3$. Comparison of deposition methods. The results of EBD and IBS samples are taken from Refs. 11 and 25, respectively. All samples were tested under identical conditions using the same experimental setup with 500 fs pulse duration at 1030 nm wavelength.
refractive index contrast, i.e., 0.2 at the wavelength of 1030 nm. Despite a lattice mismatch of only 2.5%, the fundamentally different lattice structure of Sc₂O₃ and α-Al₂O₃ (space group Ia\̅3 and R\̅3c, respectively) can potentially make the fabrication of Sc₂O₃/α-Al₂O₃ multilayer coatings more complex than pairs of cubic sesquioxides. However, for example, the lattice mismatch of a Sc₂O₃/Y₂O₃ combination is too large, at 7.6%, for robust thick-multilayer epitaxial growth. Another challenge derives from the lower index contrast between these PLD-grown sesquioxide materials. For instance, a quarter-wave stack of HfO₂/SiO₂ needs a minimum of 25 layers to reach 99.9% reflectivity at normal incidence for the wavelength of 1030 nm, while an equivalent Sc₂O₃/α-Al₂O₃ mirror would require 73 layers. The resulting multilayer stack would have a full-thickness on the order of 20 μm, which is within the scope of PLD crystalline growth. Furthermore, owing to the high deposition rates achievable (15 to 20 μm/h), around 10 times faster than magnetron sputtering, 10’s-μm dimensions are entirely feasible within reasonable growth-run times.

6 Conclusion

Sc₂O₃, Y₂O₃, and Lu₂O₃ sesquioxide crystalline films, deposited by pulsed-laser deposition, were tested for sub-ps laser damage. Similar intrinsic LIDT fluences of 1.3 to 1.4 J/cm² were found for the well-grown sesquioxides, i.e., Sc₂O₃ on sapphire, Y₂O₃ on sapphire, and Lu₂O₃ on YAG, when tested with multiple pulses (100 or 1k).

The LIDT tests on Lu₂O₃ grown on sapphire revealed significantly lower damage thresholds than Lu₂O₃ on YAG. This result is explained by the polycrystalline structure of Lu₂O₃ grown on sapphire, deduced from XRD characterization. The highly textured polycrystalline structure contains discontinuities in the lattice that most probably initiate the damage.

The high-index PLD sesquioxides show high bandgap values indicating good damage resistance in optical coatings. In terms of observed damage thresholds, sesquioxides can compete with HfO₂, a frequently used high-index material in dielectric multilayers. The study shows that pulsed-laser deposition is a candidate for optical-coating fabrication and that the sesquioxides are promising high-index materials that could be used in applications relating to high-power ultrashort-pulse lasers.

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Data, Materials, and Code Availability

Data underlying the results presented in this paper are not publicly available now but may be obtained from the authors upon reasonable request.

References


Biographies of the authors are not available.